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U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

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		Attorney Docket No.: 041501-5369		
To the Assistant Commissioner for Patents: Please record the attached original documents or copy thereof.		ATTN: BOX ASSIGNMENT		
<ol> <li>Name of conveying party(ies):</li> <li>Sang Moo JEONG</li> <li>Additional name(s) of conveying party(ies) attached?</li> </ol>		2. Name and address of receiving party(ies):  Name: Hyundai Electronics Industries Co., Ltd.		
Yes <u>_X</u> No		Internal Address:		
3. Nature of conveyance:  X AssignmentMerger		Street Address: San 136-1, Ami-ri, Bubal-eub, Ichon-shi, Kyoungki-do, Korea		
Assignment Merger Security Agreement Change of Name Other		City: State: Zip:		
Execution Date:	October 25, 1999	Additional name(s) & address(es) attached?  YesX No		
4. Application number(s) or patent number(s):  If this document is being filed together with a new application the execution date of the application is:  October 25, 1999  A. Patent Application No.(s)  B. Patent No.(s)  Additional numbers attached: Yes X No				
	s of party to whom correspondence nent should be mailed:	6. Total number of applications and patents involved: _1		
Name: Internal Address:	Mr. Robert J. Gaybrick  Morgan, Lewis & Bockius LLP  Customer No. 09629	7. Total fee (37 C.F.R §3.41):\$40.00 X Enclosed Authorized to be charged to deposit account 50-0310		
Street Address: City: Washington	1800 M Street, N.W. <b>State:</b> D.C. <b>Zip:</b> 20036	8. Deposit account number: 50-0310 Attach duplicate of page if paying by deposit account		
9. Statement and Signature  To the best of my the original document of the second seco	knowledge and belief, the foregoing informment.	November 18, 1999  November 18, 1999  Date  of pages including cover sheet, attachments and documents: 2		
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1.

SOLE/JOINT INVENTION (U.S. Rights Only)

## **ASSIGNMENT**

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

## METHOD FOR FORMING ISOLATION REGION OF SEMICONDUCTOR DEVICE

or which I/WE executed an application for United Statetters Patent on, (Application No.		an application for United States		
WHEREAS, <u>Hyundai Electronics Industries C</u> <u>Ami-ri, Bubal-eub, Ichon-shi, Kyoungki-do, Korea (</u> nterest in and to this invention, the application for Uni his application;	Co., Ltd. , a corporation of <u>Korea</u> , whose hereinafter referred to as Assignee), is desirous ted States Letters Patent on this invention and the	of securing the entire right, title, and		
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby eknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto he assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all invisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and all kereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this avention to assignee, its successors and assigns, in accordance with the terms of this Assignment;  AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its accessors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers then called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said ssignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do verything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.  AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in his application, to insert here in parentheses (Application No				
IN TESTIMONY WHEREOF, I/WE have he	reunto set our hand(s).			
Full Name of Sole or First Assignor Sang Moo JEONG	Assignor's Signature	Date (Oct. 25, 1999		
Address Jinro APT. 701-604, Shinnae-dong, Chungnang-ku, Seoul. Korea		Citizenship Republic of Korea		
Full Name of Second Assignor	Assignor's Signature	Date		
Address		Citizenship		
Names of additional inventors attached       Yes   X   No				

Morgan, Lewis & Bockius LLP

VA01/194565.1

PATENT RECORDED: 11/18/1999 REEL: 010398 FRAME: 0343